AMENDMENTS TO THE CLAIMS

1. (Currently amended) An integrated circuit ~~device~~ chip, comprising:

a processing component on the integrated circuit chip;

a Level 1 (L1) cache and a Level 2 (L2) cache on the chip, which ~~is~~ are arranged to store data for use by the processing component responsively to an addressing scheme based on memory addresses having an address length of m_1 bits; and

first and second buses on the chip coupled between the processing component and the L1 cache, and third and fourth buses on the chip coupled between the L1 cache and the L2 cache, the first and third buses having bus widths ~~of n_1 and n_2 bits, respectively, such that $n_1 <$~~ smaller than m_1,

the processing component and the ~~cache~~ L1 and L2 caches ~~each~~ comprising ~~a~~ respective address bus expanders coupled to the first ~~bus~~ and third buses in order to compact at least some of the memory addresses for transmission over the first ~~bus~~ and third buses so that each of the at least some memory addresses is transmitted over the first ~~bus~~ and third buses in one bus cycle ~~of the first bus~~,

wherein the L1 cache comprises a table for use in compaction of address fields that is shared by the address bus expanders coupled to the first and third buses.

2. (Currently amended) The ~~device~~ chip according to claim 1, wherein the data comprise data words having a word length of m_2 bits stored at each address, such that ~~$n_1 <$~~ the second bus has a bus width smaller than m_2, and

wherein each of the processing component and the cache further comprises a respective second bus expander

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coupled to the second bus in order to compact at least some of the data words for transmission over the second bus so that each of the at least some of the data words is transmitted over the second bus in one cycle of the second bus.

3.   (Currently amended) The ~~device~~ chip according to claim 2, wherein the data words comprise data values for processing by the device, and wherein the processing component is arranged to load the compacted data words via the second bus from the cache for processing and to store the compacted data words via the second bus to the cache.

4.   (Currently amended) The ~~device~~ chip according to claim 2, wherein the data words comprise instructions for execution by the device, wherein the compacted words comprise compacted instructions, and wherein the processing component is arranged to fetch the compacted instructions via the second bus.

5.   (Currently amended) The ~~device~~ chip according to claim 2, wherein the address bus expander and the second bus expander are arranged to compact the memory addresses and the data words simultaneously, so as to transmit a compacted memory address and a compacted data word for storage at the memory address together in one cycle of the first and second buses.

6.   (Currently amended) The ~~device~~ chip according to claim 2, wherein the address bus expander and the second bus expander are arranged to compact the memory addresses and the data words by transmitting indices to values in respective tables held by the bus expanders, and wherein the cache is arranged to store at least some of the indices together with the data.

7.   (Currently amended) The ~~device~~ chip according to claim 1, wherein the address bus expander is arranged to

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compact each of the at least some of the memory addresses by dividing each of the memory addresses into at least first and second fields, storing values of the second field in a respective table such that the values in respective tables held by the address bus expander in the processing component and the address bus expander in the cache are identical, and if the second field of a memory address matches a value in the table, transmitting an index corresponding to the value over the first bus along with the first field in the one cycle of the bus.

8. (Currently amended) The ~~device~~ chip according to claim 7, wherein the first field comprises a set of least significant bits (LSB) of the memory address, while the second field comprises a set of most significant bits (MSB) of the memory address.

9. (Currently amended) The ~~device~~ chip according to claim 7, wherein the at least first and second fields comprise a third field, and wherein the address bus expander is arranged to compact each of the at least some of the memory addresses by transmitting first and second indices corresponding to the values of the first and third fields, respectively, over the first bus along with the first field.

10. (Currently amended) The ~~device~~ chip according to claim 7, wherein the address bus expander in the processing component is arranged, when the second field of the memory address does not match any of the values in the table, to transmit both of the first and second fields over multiple cycles of the bus, and to cause the respective table of the bus expander to be updated in both the processing component and the cache.

11. (Currently amended) The ~~device~~ chip according to claim 7, wherein the cache comprises lines of the data that are indexed according to the first field, each line containing a corresponding value of the second field, and

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wherein the address bus expander in the cache is arranged, upon receiving the index over the first bus, to retrieve the value of the second field from the table responsively to the index, and

wherein the cache is arranged to determine whether a cache hit has occurred by checking the retrieved value against the corresponding value of the second field in the line that is indexed by the first field.

12. (Currently amended) The ~~device~~ <u>chip</u> according to claim 11, wherein the address bus expander is arranged to retrieve the value of the second field from the table simultaneously with retrieval of the data from the line in the cache that is indexed by the first field for transmission of the data over the second bus to the processing component.

13. (Canceled)

14. (Currently) A method for coupling a processing component <u>on an integrated circuit chip</u> to a <u>Level 1</u> cache ~~in an~~ <u>and a Level 2 cache on the</u> integrated circuit ~~device~~ <u>chip</u>, the method comprising:

configuring the <u>Level 1 and Level 2</u> caches to store data for use by the processing component responsively to an addressing scheme based on memory addresses having an address length of m_1 bits;

coupling first and second buses ~~coupled~~ <u>on the chip</u> between the processing component and the <u>L1</u> cache, <u>and third and fourth buses on the chip coupled between the L1 cache and the L2 cache,</u> the <u>first and third</u> buses having bus widths ~~of n_1 and n_2 bits, respectively, such that n_1 <~~ <u>smaller than</u> m_1;

compacting at least some of the memory addresses for transmission over the first ~~bus~~ <u>and third buses using a table in the L1 cache that is shared by address bus expanders coupled to the first and third buses,</u> so that each of the at least some memory addresses can be

transmitted over the first ~~bus~~ and third buses in one bus cycle;

transmitting at least the compacted memory addresses over the first ~~bus~~ and third buses; and

conveying the data over the second ~~bus~~ and fourth buses responsively to the compacted memory addresses.

15. (Currently amended) The method according to claim 14, wherein the data comprise data words having a word length of m_2 bits stored at each address, such that ~~$n_2 <$~~ the second bus has a bus width smaller than m_2, and

wherein conveying the data comprises compacting at least some of the data words for transmission over the second bus so that each of the at least some of the data words is transmitted over the second bus in one cycle of the second bus.

16. (Currently amended) The method according to claim 15, wherein the data words comprise data values for processing by the integrated circuit ~~device~~ chip, and wherein conveying the data comprises loading the compacted data words via the second bus from the cache for processing by the processing component, and storing the compacted data words from the processing component via the second bus to the cache.

17. (Currently amended) The method according to claim 15, wherein the data words comprise instructions for execution by the ~~device~~ chip, wherein the compacted words comprise compacted instructions, and wherein conveying the data comprises fetching the compacted instructions from the cache via the second bus to the processing component.

18. (Original) The method according to claim 15, wherein compacting the at least some of the memory addresses and compacting at least some of the data words comprise compacting at least a portion of the memory addresses and the data words simultaneously, so as to transmit a

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compacted memory address and a compacted data word for storage at the memory address together in one cycle of the first and second buses.

19. (Original) The method according to claim 15, wherein compacting the at least some of the memory addresses and compacting at least some of the data words comprise compacting the memory addresses and the data words by transmitting indices to values in respective tables held in the cache and the processing component, and storing at least some of the indices in the cache together with the data.

20. (Original) The method according to claim 14, wherein compacting the at least some of the memory addresses comprises:

dividing each of the at least some of the memory addresses into at least first and second fields; and

storing values of the second field in a respective table such that the values in respective tables held in the processing component and in the cache are identical, and

wherein transmitting at least the compacted memory addresses comprises, if the second field of a memory address matches a value in the table, transmitting an index corresponding to the value over the first bus along with the first field in the one cycle of the bus.

21. (Original) The method according to claim 20, wherein the first field comprises a set of least significant bits (LSB) of the memory address, while the second field comprises a set of most significant bits (MSB) of the memory address.

22. (Original) The method according to claim 20, wherein the at least first and second fields comprise a third field, and wherein transmitting the index comprises transmitting first and second indices corresponding to

the values of the first and third fields, respectively, over the first bus along with the first field.

23. (Original) The method according to claim 20, wherein transmitting at least the compacted memory addresses comprises, when the second field of the memory address does not match any of the values in the table, transmitting both of the first and second fields over multiple cycles of the bus, and updating the respective table in both the processing component and the cache.

24. (Currently amended) The method according to claim 20, wherein configuring the cache comprises indexing lines of the data ~~that~~ according to the first field, each line containing a corresponding value of the second field, and wherein conveying the data comprises:

receiving the index in one of the compacted memory addresses over the first bus; and

determining whether a cache hit has occurred by retrieving the value of the second field from the table responsively to the index, and checking the retrieved value against the corresponding value of the second field in the line that is indexed by the first field.

25. (Original) The method according to claim 24, wherein determining whether the cache hit has occurred comprises simultaneously retrieving the value of the second field from the table and retrieving the data from the line that is indexed by the first field for transmission over the second bus to the processing component.

26. (Canceled)